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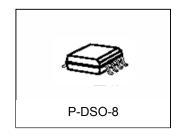




Data Sheet

TDA21106

High speed Driver with bootstrapping for dual Power MOSFETs



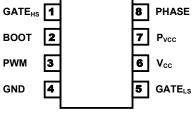
Features

- Fast rise and fall times for frequencies up to 2 MHz
- Capable of sinking more than 4A peak currents for lowest switching losses
- Charges High Side MOSFET gate drive voltage from 6 to 12V according to PVCC setting; Low Side MOSFET at 12 V.
- Adjustable High Side MOSFET gate drive voltage via PVCC pin for optimizing ON losses and gate drive losses
- Integrates the bootstrap diode for reducing the part count
- Prevents from cross-conducting by adaptive gate drive control
- High voltage rating on Phase node
- Supports shut-down mode for very low guiescent current through three-state input
- Compatible to standard PWM controller ICs (Intersil, Analog Devices)
- Floating High Side MOSFET drive
- Footprint compatible to TDA21101G and HIP6601B
- Ideal for multi-phase Desktop CPU supplies on motherboards and VRM's

Type	Package	Marking	Ordering Code
TDA21106	P-DSO-8	21106	Q67042-S4223

Top View

Pinout



Number	Name	Description
1	GATE _{HS}	Gate drive output for the N-Channel High side MOSFET
2	ВООТ	Floating bootstrap pin. To be connected to the external bootstrap capacitor to generate the gate drive voltage for the high side N-Channel MOSFET
3	PWM	Input for the PWM controller signal
4	GND	Ground
5	GATE _{LS}	Gate drive output for the N-Channel Low Side MOSFET
6	VCC	Supply voltage
7	PVCC	Input to adjust the High Side gate drive
8	PHASE	To be connected to the junction of the High Side and the Low Side MOSFET



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General Description

The dual high speed driver is designed to drive a wide range of N-Channel low side and N-Channel high side MOSFETs with varying gate charges. It has a small propagation delay from input to output, short rise and fall times and the same pin configuration to be compatible to TDA21101G and HIP6601B. In addition it provides protection features as well as a three-state mode for efficiency reasons. The high breakdown voltage makes it suitable for mobile applications.

Target application

The dual high speed driver is designed to work well in half-bridge type circuits where dual N-Channel MOSFETs are utilized. A circuit designer can fully take advantage of the driver's capabilities in high-efficiency, high-density synchronous DC/DC converters that operate at high switching frequencies, e.g. in multi-phase converters for CPU supplies on motherboards and VRM's but also in motor drive and class-D amplifier type applications.

Absolute Maximum Ratings

At Tj = 25 °C, unless otherwise specified

Parameter	Symbol	Va	alue	Unit
		Min.	Max.	
Voltage supplied to 'VCC' pin; DC	V_{VCC}	-0.3	25	
Voltage supplied to 'PVCC' pin; DC	V_{PVCC}	-0.3	25	
Voltage supplied to 'PWM' pin	V_{PWM}	-0.3	5,5	
Voltage supplied to 'BOOT' pin referenced to 'PHASE'	V _{BOOT} –	-0,3	25	V
	V_{PHASE}			
Voltage supplied to 'BOOT' pin referenced to 'GND'	V_{BOOT}	-0,3	45	
Voltage rating at 'PHASE' pin, DC	V_{PHASE}	-1	25	
Voltage rating at 'PHASE' pin, t _{pulse_max} = 500ns	V_{PHASE}	-20	30	
Max Duty Cycle = 2%				
Voltage supplied to GATE _{HS} pin referenced to 'PHASE'	V_{GATEHS}	-3.5	V_{BOOT}	
T _{pulse max} < 100ns, Energy < 2uJ			+0.3	
Voltage supplied to GATE _{LS} pin referenced to 'GND'	V_{GATELS}	-5	V_{VCC}	
T _{pulse_max} < 100ns, Energy < 2uJ			+0.3	
Junction temperature	TJ	-25	150	°C
Storage temperature	Ts	-55	150	
ESD Rating; Human Body Model			4	KV
IEC climatic category; DIN EN 60068-1		55/1	50/56	-



Data Sheet

TDA21106

Thermal Characteristic

Parameter S		Values		Unit	
		Min.	Тур.	Max.	
Thermal resistance, junction-soldering point			95		K/W
Thermal resistance, junction-ambient			125		

Operating ConditionsAt Tj = 25 °C, unless otherwise specified

Parameter	Symbol	Conditions	Values		Unit	
	_		Min.	Тур.	Max.	
Voltage supplied to 'VCC' pins	V _{VCC}		10.8		13.2	V
Voltage supplied to 'PVCC' pins	V_{PVCC}		6		13.2	V
Input signal transition frequency	f		0.1		2	MHz
Power dissipation	P _{TOT}	$T_A = 25 ^{\circ}\text{C}, T_J = 125 ^{\circ}\text{C}$		8.0		W
Junction temperature	T_J		-25		150	°C

Electrical Characteristic

At Ti = 25 °C. unless otherwise specified

Parameter	Symbol	Conditions		Values	3	Unit
			Min.	Тур.	Max.	
Supply Characteristic	•					
Quiescent current	I _{PVCC} +I _{VCCQ}	$1.8~V \leq V_{PWM} \leq 3.0~V$		1,3.	3	
VCC supply current	I _{vcc}	f =1 MHz,				
		$V_{PVCC} = V_{VCC} = 12 V$ No load		5	8	mA
PVCC supply current	I _{PVCC}	f =1 MHz,				
	1 700	$V_{PVCC} = V_{VCC} = 12 V$ No load		6	8.5	
Under-voltage		V _{VCC} rising threshold	9.7	10.1	10.5	V
lockout						
Under-voltage		V _{VCC} falling threshold	7.3	7.6	8.0	
lockout						
Input Characteristic						
Current in 'PWM' pin	I _{PWM L}	$V_{PWM} = 0.4 V$	-80	-115	-150	μΑ
Current in 'PWM' pin	I _{PWM H}	$V_{PWM} = 4.5 V$	120	180	250	
Shut down window	V _{IN SHUT}	t_ _{SHUT} > 300 ns	1.7		3.1	V
Shut down hold-off	t_s _{HUT}	$1.6~V \leq V_{PWM} \leq 3.2~V$	100	190	300	ns
time						
PWM pin open	V_{PWM_O}		1.8	2.0	2.2	
PWM Low level	V _{PWM L}				1.4	
PWM High level	V _{PWM H}		3.7			V
Pulse width High	t_ _P	= Pulse width on PWM		40		ns
Side	_	pin				



Data Sheet

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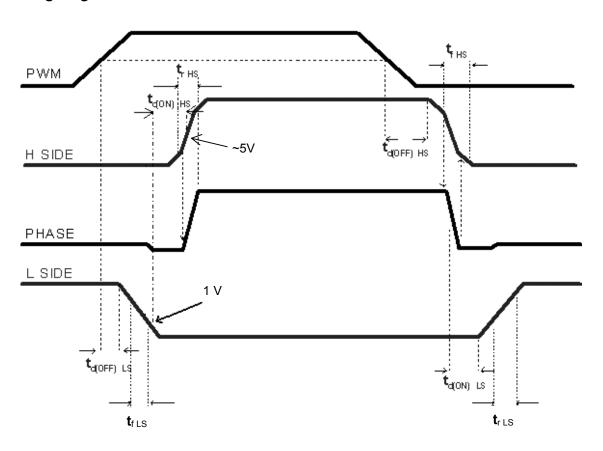
At Tj = 25 °C, unless otherwise specified

Dynamic Characteristic							
Turn-on propagation	t _{d(ON)_HS}			20	35		
Delay High Side							
Turn-off propagation	$t_{d(OFF)_HS}$			15	25		
delay High Side							
Rise time High Side	t_r HS			20	33		
Fall time High Side	t_{f_HS}	$P_{PVCC} = V_{VCC} = 12 V$		15	25	ns	
Turn-on propagation	$t_{d(ON)_LS}$	$C_{ISS} = 3000 pF$		15	27		
Delay Low Side							
Turn-off propagation	t _{d(OFF)_LS}			10	20		
delay Low Side							
Rise time Low Side	t_{r_LS}			20	33		
Fall time Low Side	t_{f_LS}			15	25		

At Tj = 125 °C, unless otherwise specified

At 1] = 125 °C, unless otherwise specified						
Dynamic Characteris	tic					
Turn-on propagation	t _{d(ON)_HS}			25		
Delay High Side	` /=					
Turn-off propagation	t _{d(OFF)_HS}			18		
delay High Side						
Rise time High Side	t _{r HS}			24		
Fall time High Side	t_f HS	$P_{PVCC} = V_{VCC} = 12 V$		22		ns
Turn-on propagation	t _{d(ON)_LS}	$C_{ISS} = 3000 \text{ pF}$		18		
Delay Low Side	`					
Turn-off propagation	t _{d(OFF)_LS}			15		
delay Low Side	, ,_					
Rise time Low Side	$t_{r_{LS}}$			21		
Fall time Low Side	t _{f LS}			19		

Timing diagram

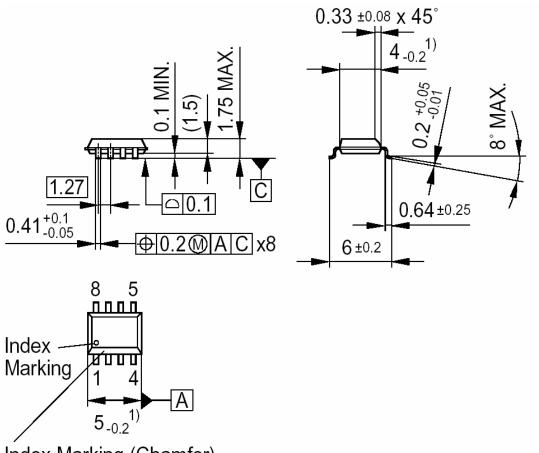


At Ti = 25 °C, unless otherwise specified

Parameter		Conditions		Values		Unit
			Min.	Тур.	Max.	
Output Character	ristic High Side	e (HS) and Low Side (LS), e	ensure	d by d	lesign	
Output	HS; Source	$V_{PVCC} = V_{VCC} = 12 V$				
Resistance		$I_{HS_SRC} = 2 A$		1 (1)		Ω
	HS; Sink	$V_{PVCC} = V_{VCC} = 12 V$		0.9	1.3	Ω
	LS; Source	$V_{PVCC} = V_{VCC} = 12 V$				
		$I_{HS_SRC} = 2 A$		1.4 (2)		Ω
	LS; Sink	$V_{PVCC} = V_{VCC} = 12 V$		0.9	1.3	Ω
	HS; Source	$V_{PVCC} = V_{VCC} = 12 V$	4			
Peak output-	HS; Sink	t_ _{P_HS} / Pulse < 20 ns	4			Α
current	LS; Source	t_{P_LS} / Pulse < 40 ns	4			
	LS; Sink		4			

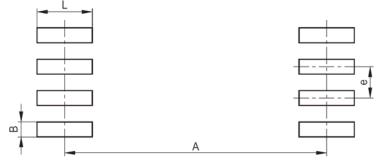
 $^{^1}$ Incremental resistance V_BOOT-V_GATEHS=4.3V @ I_SOURCE=2A 2 Incremental resistance V_VCC -V_GATELS=4.4V @ I_SOURCE=2A

Package Drawing P-DSO-8-3



Index Marking (Chamfer)

Footprint Drawing P-DSO-8-3



е	Α	L	В
1,27 mm	5,69 mm	1,31 mm	0,65 mm

¹⁾ Does not include plastic or metal protrusion of 0.15 max. per side



CoreControl[™] Data Sheet TDA21106

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